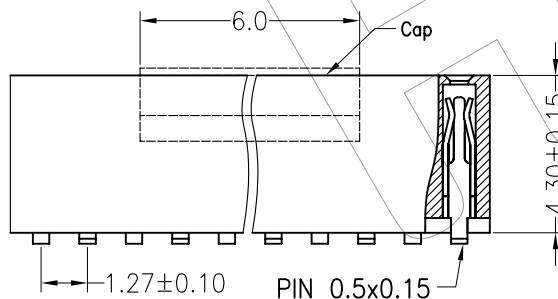
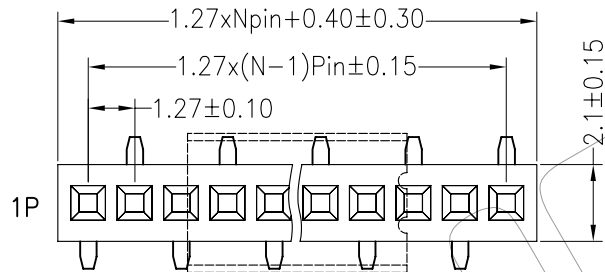
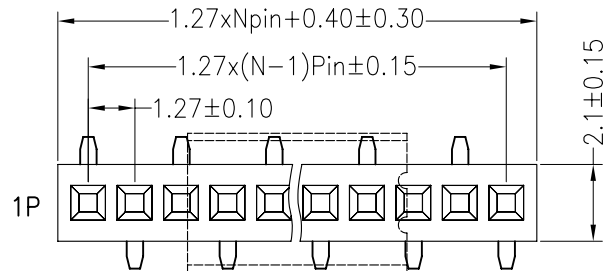
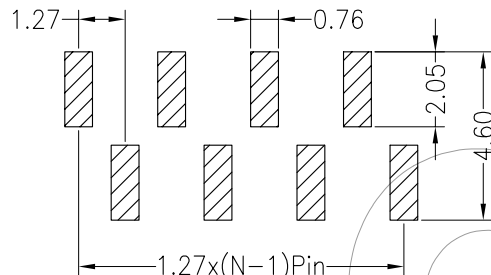


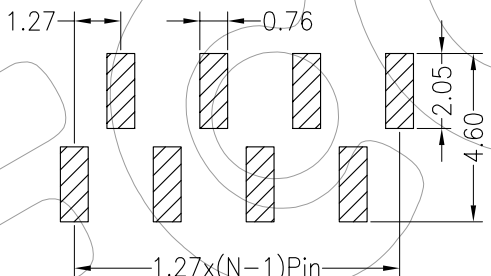
RoHS



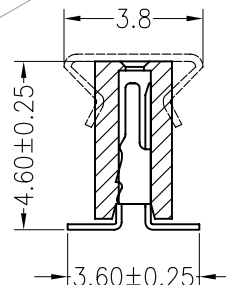
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE02



TYPE01



SPECIFICATIONS

Rated Current:1.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze

Contact Plating:Au Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Ordering Information

HC-FH743 01 XX X N XX MUX 0X(1,2)

No. of
Pins
Per Row
1*50

Insulator Material
Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
E=BK-PA9T
F=BK-LCP

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ±0.30

X.XX ±0.20

X.XXX ±0.10

Angle ±3°

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

◆

HECON

东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH74301XXNXXMUX0X(1,2)

TITLE:

1.27mm H4.3 Single Row SMT Female Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

DIM

TOL

APPROVE

PROJ.

◆

TITLE:

1.27mm H4.3 Single Row SMT Female Header